## SupIRBuck ${ }^{\text {m }}$

## USER GUIDE FOR IRDC3476 EVALUATION BOARD

## DESCRIPTION

The IR3476 SupIRBuck ${ }^{\text {TM }}$ is an easy-to-use, fully integrated and highly efficient DC/DC voltage regulator. The onboard constant on time hysteretic controller and MOSFETs make IR3476 a space-efficient solution that delivers up to 12A of precisely controlled output voltage. IR3476 is housed in a 20-lead 5 mmx 6 mm QFN package.

Key features offered by IR3476 include: programmable switching frequency, soft start, temperature compensated over current protection, and thermal shutdown allowing a very flexible solution suitable for many different applications and an ideal choice for battery powered applications.

Additional features include pre-bias startup, a very precise 0.5 V reference, forced continuous conduction mode option, over/under voltage protection, power good output, and enable input with voltage monitoring capability.

This user guide contains the schematic, bill of materials, and operating instructions of the IRDC3476 evaluation board. Detailed product specifications, application information and performance curves at different operating conditions are available in the IR3476 data sheet.

## BOARD FEATURES

- $\mathrm{V}_{\mathrm{IN}}=+12 \mathrm{~V}$
- $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}$
- $\mathrm{V}_{\text {OUT }}=+1.05 \mathrm{~V}$
- $\mathrm{I}_{\text {OUt }}=0$ to 12 A
- $\mathrm{F}_{\mathrm{s}}=300 \mathrm{kHz}$ @ CCM
- $L=1.5 \mu \mathrm{H}$
- $\mathrm{C}_{\mathrm{IN}}=22 \mu \mathrm{~F}$ (ceramic 1210) $+68 \mu \mathrm{~F}$ (electrolytic)
- $\mathrm{C}_{\text {OUT }}=47 \mu \mathrm{~F}$ (ceramic 0805) $+330 \mu \mathrm{~F}$ (PC-CON)


## CONNECTIONS and OPERATING INSTRUCTIONS

An input supply in the range of 8 to 19 V should be connected from VIN to PGND. A maximum load of 12A may be connected to $\mathrm{V}_{\text {OUT }}$ and PGND. The connection diagram is shown in Fig. 1, and the inputs and outputs of the board are listed in Table 1.

IRDC3476 has two input supplies, one for biasing (VCC) and the other for input voltage (VIN). Separate supplies should be applied to these inputs. VCC input should be a well regulated 4.5 V to 5.5 V supply connected to VCC and PGND. Enable (EN) is controlled by the first switch of SW1, and FCCM option can be selected by the second switch of SW1. Toggle the switch to the ON position (marked by a solid square) to enable switching or to select FCCM. The absolute maximum voltage of the external signal applied to EN (TP4) and FCCM (TP3) is +8 V .

Table 1. Connections

| Connection |  |
| :--- | :--- |
| VIN (TP2) | VIN |
| PGND (TP5) | Ground Connection for VIN |
| VCC (TP16) | VCC Input |
| PGND (TP17) | Ground Connection for VCC Input |
| VOUT (TP7) | V $_{\text {OUT }}(+1.05 \mathrm{~V})$ |
| PGND (TP10) | Ground Connection for $V_{\text {OUT }}$ |
| EN (TP4) | Enable Input |
| FCCM (TP3) | Forced Continuous Conduction Mode Input |

## LAYOUT

The PCB is a 4-layer board. All layers are 1 oz. copper. IR3476 and other components are mounted on the top and bottom layers of the board.

The power supply decoupling capacitors, bootstrap capacitor and feedback components are located close to IR3476. To improve efficiency, the circuit board is designed to minimize the length of the onboard power ground current path.

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IRDC3476

## CONNECTION DIAGRAM



Fig. 1: Connection Diagram of IRDC3476 Evaluation Board

## PCB Board Layout



Fig. 2: Board Layout, Top Components


Fig. 3: Board Layout, Bottom Components

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Fig. 4: Board Layout, Top Layer


Fig. 5: Board Layout, Bottom Layer

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Fig. 6: Board Layout, Mid-layer I


Fig. 7: Board Layout, Mid-layer II


Fig. 8: Schematic of the IRDC3476 Evaluation Board

## Bill of Materials

| QTY | REF DESIGNATOR | VALUE | DESCRIPTION | MANUFACTURER | PART NUMBER |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 3 | C1, C21, C25 | 1.00uF | capacitor, X7R, 1.00uF, 25V, 0.1, 0603 | Murata | GRM188R71E105KA12D |
| 1 | C10 | 47uF | capacitor, 47uF, 6.3V, 805 | TDK | C2012X5R0J476M |
| 29 | C11, C13, C14, C15, C16, C17, C18, C19, C22, C23, C24, C26, C27, C5, C6, C7, C8, R11, R12, R13, R14, R6, TP10, TP12, TP18, TP2, TP5, TP7, TP8 | - | Not Installed | - | - |
| 2 | C12, C20 | 0.100uF | capacitor, X7R, 0.100uF, 50V, 0.1, 603 | TDK | C1608X7R1H104K |
| 1 | C2 | 22.0uF | capacitor, X5R, 22.0uF, 16V, 20\%, 1206 | Taiyo Yuden | EMK316BJ226ML-T |
| 1 | C3 | 68uF | capacitor, electrolytic, $68 \mathrm{uF}, 25 \mathrm{~V}, 0.2$, SMD | Panasonic | EEV-FK1E680P |
| 1 | C4 | 0.220uF | capacitor, Y5V, $0.220 \mathrm{uF}, 50 \mathrm{~V},-20 \%,+80 \%, 0603$ | MuRata | GRM188F51H224ZA01D |
| 1 | C9 | 330uF | capacitor, $330 \mathrm{uF}, 2.5 \mathrm{~V}, 0.2,7343$ | Sanyo | 2R5TPE330M9 |
| 1 | L1 | 1.5uH | inductor, ferrite, $1.5 \mathrm{uH}, 16.0 \mathrm{~A}, 3.8 \mathrm{mOhm}$, SMT | Cyntec | PIMB104T-1R5MS-39 |
| 3 | R1, R2, R5 | 10.0K | resistor, thick film, 10.0K, 1/10W, 0.01, 0603 | KOA | RK73H1J1002F |
| 1 | R3 | 200K | resistor, thick film, 200K, 1/10W, 0.01, 603 | KOA | RK73H1JLTD2003F |
| 1 | R4 | 10.5K | resistor, thick film, 10.5K, 1/10W, 0.01, 603 | KOA | RK73H1JLTD1052F |
| 1 | R7 | 2.80 K | resistor, thick film, 2.80K, 1/10W, 0.01, 603 | KOA | RK73H1JLTD2801F |
| 1 | R8 | 2.55 K | resistor, thick film, $2.55 \mathrm{~K}, 1 / 10 \mathrm{~W}, 0.01,0603$ | KOA | RK73H1J2551F |
| 1 | SW1 | Switch | switch, DIP, SPST, 2 position, SMT | C\&K Components | SD02H0SK |
| 19 | TP1, TP11, TP13, TP14, TP15, TP16, TP17, TP19, TP20, TP21, TP22, TP23, TP24, TP25, TP26, TP3, TP4, TP6, TP9 | 60 mils | hardware, test point, 60 mils, $40 \times 105$ mils, 5015 | Keystone | 5015 |
| 1 | U1 | IR3476 | $5 \mathrm{~mm} \times 6 \mathrm{~mm}$ QFN | IRF | IR3476 |

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## TYPICAL OPERATING WAVEFORMS

Tested with demoboard shown in Fig. 8, VIN $=12 \mathrm{~V}, \mathrm{VCC}=5 \mathrm{~V}$, VOUT $=1.05 \mathrm{~V}$, $\mathrm{Fs}=300 \mathrm{kHz}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, no airflow, unless otherwise specified


Fig. 9: Startup


Fig. 11: $\operatorname{DCM}\left(I_{\text {OUT }}=0.1 \mathrm{~A}\right)$


Fig. 13: Over Current Protection (tested by shorting VOUT to PGND on demoboard)


Fig. 10: Shutdown


Fig. 12: $\mathrm{CCM}\left(\mathrm{I}_{\text {OUT }}=12 \mathrm{~A}\right)$


Fig. 14: Over Voltage Protection (tested by shorting FB to VOUT)

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TYPICAL OPERATING WAVEFORMS
Tested with demoboard shown in Fig. 8, VIN $=12 \mathrm{~V}, \mathrm{VCC}=5 \mathrm{~V}$, VOUT $=1.05 \mathrm{~V}$, $\mathrm{Fs}=300 \mathrm{kHz}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, no airflow, unless otherwise specified


Fig. 15: Load Transient 0-8A


Fig. 16: Load Transient 8-12A

## TYPICAL PERFORMANCE

$\mathrm{VIN}=12 \mathrm{~V}, \mathrm{VCC}=5 \mathrm{~V}, \mathrm{VOUT}=1.05 \mathrm{~V}, \mathrm{Fs}=300 \mathrm{kHz}, \mathrm{IOUT}=12 \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, no airflow


Fig. 17: Thermal Image (IR3476: $98^{\circ} \mathrm{C}$, Inductor: $58^{\circ} \mathrm{C}, \mathrm{PCB}: 47^{\circ} \mathrm{C}$ )

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TYPICAL OPERATING DATA
$\mathrm{VIN}=12 \mathrm{~V}, \mathrm{VCC}=5 \mathrm{~V}, \mathrm{VOUT}=1.05 \mathrm{~V}$, $\mathrm{Fs}=300 \mathrm{kHz}$, $\mathrm{IOUT}=0 \sim 12 \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, no airflow, unless otherwise specified


Fig. 18: Efficiency vs. Output Current


Fig. 20: Load Regulation


Fig. 19: Switching Frequency vs. Output Current


Fig. 21: Line Regulation at 12A Load

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## PCB Metal and Components Placement

Lead lands (the 13 IC pins) width should be equal to nominal part lead width. The minimum lead to lead spacing should be $\geq 0.2 \mathrm{~mm}$ to minimize shorting.

Lead land length should be equal to maximum part lead length +0.3 mm outboard extension. The outboard extension ensures a large toe fillet that can be easily inspected.

Pad lands (the 4 big pads) length and width should be equal to maximum part pad length and width. However, the minimum metal to metal spacing should be no less than; 0.17 mm for 2 oz . Copper or no less than 0.1 mm for 1 oz . Copper or no less than 0.23 mm for 3 oz . Copper.


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## Solder Resist

It is recommended that the lead lands are Non Solder Mask Defined (NSMD). The solder resist should be pulled away from the metal lead lands by a minimum of 0.025 mm to ensure NSMD pads.

The land pad should be Solder Mask Defined (SMD), with a minimum overlap of the solder resist onto the copper of 0.05 mm to accommodate solder resist misalignment.
Ensure that the solder resist in between the lead lands and the pad land is $\geq 0.15 \mathrm{~mm}$ due to the high aspect ratio of the solder resist strip separating the lead lands from the pad land.


$$
\begin{aligned}
& \text { All Dimensions In mm } \\
& \text { All Pads are Solder Mask Defined } \\
& \text { Pad Center to Center dimensions }
\end{aligned}
$$



Component Pad

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## Stencil Design

The Stencil apertures for the lead lands should be approximately $80 \%$ of the area of the lead lads. Reducing the amount of solder deposited will minimize the occurrences of lead shorts. If too much solder is deposited on the center pad the part will float and the lead lands will open.

The maximum length and width of the land pad stencil aperture should be equal to the solder resist opening minus an annular 0.2 mm pull back in order to decrease the risk of shorting the center land to the lead lands when the part is pushed into the solder paste.


IRDC3476

| DIM | MILIMITERS |  | INCHES |  | DIM | MILIMITERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  | MIN | MAX | MIN | MAX |
| A | 0.800 | 1.000 | 0.0315 | 0.0394 | L | 0.350 | 0.450 | 0.0138 | 0.0177 |
| A1 | 0.000 | 0.050 | 0.0000 | 0.0020 | M | 2.441 | 2.541 | 0.0961 | 0.1000 |
| b | 0.375 | 0.475 | 0.1477 | 0.1871 | N | 0.703 | 0.803 | 0.0277 | 0.0316 |
| b1 | 0.250 | 0.350 | 0.0098 | 0.1379 | O | 2.079 | 2.179 | 0.0819 | 0.0858 |
| c | 0.203 REF. |  | 0.008 REF. |  | P | 3.242 | 3.342 | 0.1276 | 0.1316 |
| D | 5.000 BASIC |  | 1.969 BASIC |  | Q | 1.265 | 1.365 | 0.0498 | 0.0537 |
| E | 6.000 BASIC |  | 2.362 BASIC |  | R | 2.644 | 2.744 | 0.1041 | 0.1080 |
| e | 1.033 BASIC |  | 0.0407 BASIC |  | S | 1.500 | 1.600 | 0.0591 | 0.0630 |
| e1 | 0.650 BASIC |  | 0.0256 BASIC |  | t1, t2, t3 | 0.401 | ASIC | 0.016 | ACIS |
| e2 | 0.852 BASIC |  | 0.0335 BASIC |  | t4 | 1.153 | BASIC | 0.045 | BASIC |
|  |  |  |  |  | t5 | 0.727 | ASIC | 0.0286 | BASIC |



FRONT VIEW

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